

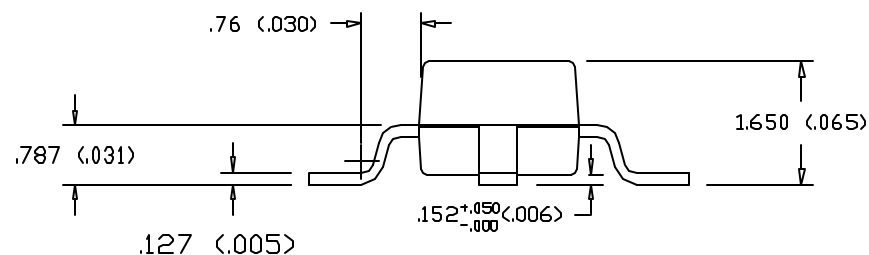
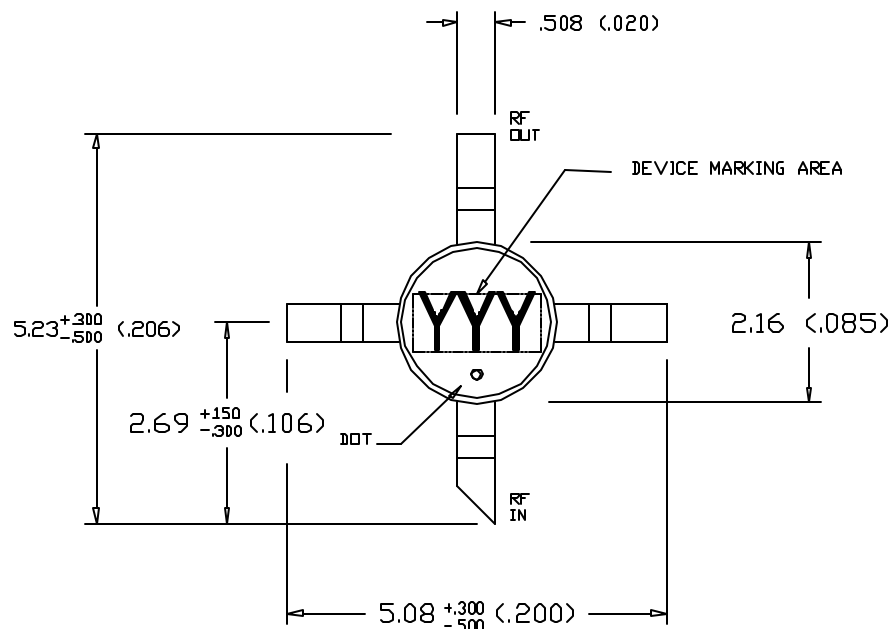
**Scanned Datasheet**

Notice: You cannot copy or search the text in this PDF file, because this PDF file is converted from a scanned image of printed materials.

**Resources**

[Datasheet Archive - Datasheet & Application Note Search Engine](#)

[SupplyFrame - Datasheet & Application Note Search Engine](#)



UNLESS OTHERWISE SPECIFIED,  
DIMENSIONS ARE IN mm (inches)  
PER ANSI Y14.5M-1982.

TOLERANCES ARE:  
DECIMAL ANGLE  
.XX ±.12 (.005) ±1/2°  
.XXX ±.05 (.002)

MATERIAL(S):

See Notes

FINISH:

See Notes

Notes:

1. Base Metal - Copper D119 194

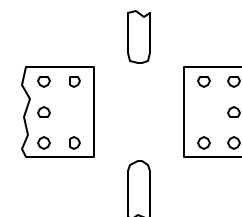
2. Lead Finish

Basic PN - Sn/Pb Sn =>80%

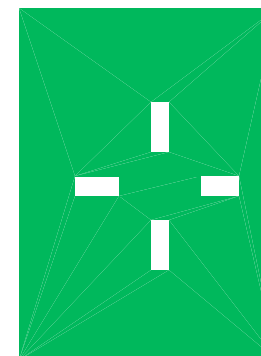
Z option - 100% Matte Sn - .01 (.0004) thk min

- Do Not Scale Hard Copy -

Caution: The Land Patterns and Solder Mask shown are generic for this package. Refer to product data sheet for any required variations specific to an application.



Scale 4:1  
- Generic Land Pattern -



Scale 4:1  
- Generic Solder Mask Opening -



Package Type:

SOT-86 (Micro X) 4 Id

SMDI Package Type: XXX-XX86

Dwg No.

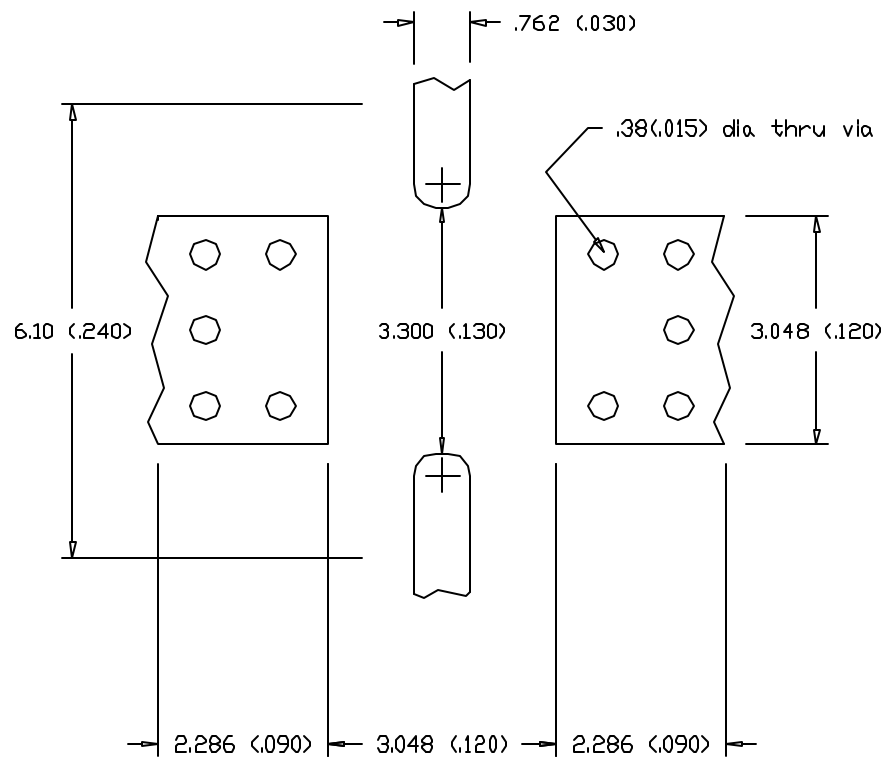
MP0-100133

Sht

1 of 2

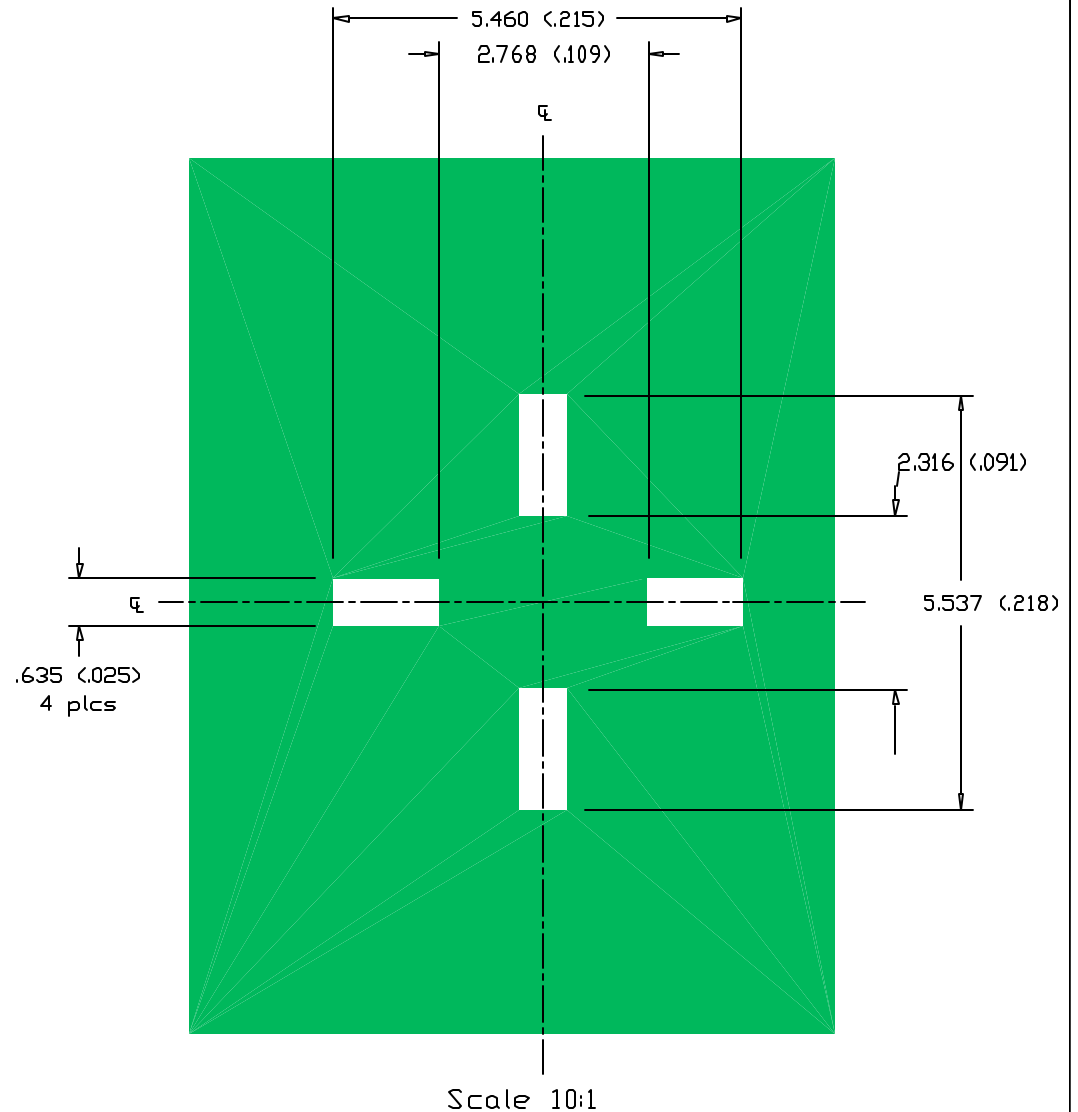
REV

C



Scale 10:1

- Generic Land Pattern -



- Generic Solder Mask Opening -

- Do Not Scale Hard Copy -

|                                     |            |               |          |
|-------------------------------------|------------|---------------|----------|
| <b>SIRENZA</b><br>MICRODEVICES      |            |               |          |
| Package Type: SOT-86 (Micro X) 4 Id |            |               |          |
| SMDI Package Type: XXX-XX86         |            |               |          |
| Dwg No.                             | MP0-100133 | Sht<br>2 of 2 | REV<br>C |